Vishay Siliconix

N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	30					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0075					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0120					
Q _g typ. (nC)	4.5					
I _D (A) ^a	38					
Configuration	Single					

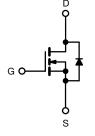
FEATURES

- TrenchFET® Gen IV power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- High power density DC/DC
- Synchronous rectification
- VRMs and embedded DC/DC



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiRA28BDP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	30	V	
Gate-source voltage		V _{GS}	+20, -16	¬	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		38		
	T _C = 70 °C		30		
	T _A = 25 °C	I _D	18 ^{b, c}		
	T _A = 70 °C		14 ^{b, c}	^	
Pulsed drain current (t = 100 μs)		I _{DM}	90	A	
Continuous source-drain diode current	T _C = 25 °C	1	16		
	T _A = 25 °C	I _S	3.4 b, c		
Single pulse avalanche current		I _{AS}	10		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	5	mJ	
	T _C = 25 °C		17		
Maximum power dissipation	T _C = 70 °C		11	14/	
	T _A = 25 °C	P _D	3.8 b, c	W	
	T _A = 70 °C		2.4 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	80	
Soldering recommendations (peak temperature) d, e		J	260	→ °C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SMYBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R _{thJA}	25	33	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	5.5	7.2	C/ VV

Notes

- a. Based on T_C = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 70 °C/W



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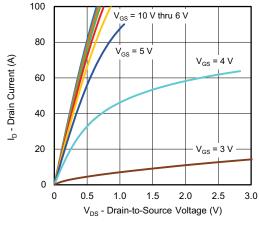
SPECIFICATIONS ($T_J = 25 ^{\circ}C$, t	inless otherv	vise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	
Drain-source breakdown voltage ^(c) (transient)	V _{DSt}	$V_{GS} = 0 \text{ V}, I_{D(aval)} = 35 \text{ A}, \\ t_{transcient} \le 50 \text{ ns}$	36	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	17	-	\//°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-3.8	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	-	2.4	V
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +20, -16 V	-	-	± 100	nA
Zana mata walta sa aluain awumant		V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	•
Zero gate voltage drain current	IDSS	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α
Data and a state and a second		V _{GS} = 10 V, I _D = 10 A	-	0.0061	0.0075	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$	-	0.0093	0.0120	Ω
Forward transconductance a	9 _{fs}	$V_{DS} = 10 \text{ V}, I_D = 25 \text{ A}$	-	35	-	S
Dynamic ^b		-	1	1	L	L
Input capacitance	C _{iss}			582	-	
Output capacitance	Coss		-	231	-	pF
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	31	-	1	
C _{rss} /C _{iss} ratio			_	0.06	0.12	
	_	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A	-	9.3	14	
Total gate charge	Q_g	, 40 , 5	-	4.5	6.8	
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	_	2.2	-	nC
Gate-drain charge	Q _{gd}	30 . 40	-	1.2	-	
Output charge	Q _{oss}	V _{DS} = 15 V, V _{GS} = 0 V	-	6.2	-	
Gate resistance	R _g	f = 1 MHz	1.4	7	14	Ω
Turn-on delay time	t _{d(on)}		-	10	20	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$	-	5	10	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	17	30	
Fall time	t _f		-	5	10	ns
Turn-on delay time	t _{d(on)}		-	16	30	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_{I} = 1.5 \Omega$	-	76	150	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_q = 1 \Omega$	-	16	35	1
Fall time	t _f	· ·	_	17	35	
Drain-Source Body Diode Characteristi						l
Continuous source-drain diode current	Is	T _C = 25 °C	<u> </u>	_	16	
Pulse diode forward current ^a	I _{SM}	<u> </u>	_	-	90	Α
Body diode voltage	V _{SD}	I _S = 5 A	_	0.8	1.1	V
Body diode reverse recovery time	t _{rr}	0	_	15	30	ns
Body diode reverse recovery charge	Q _{rr}	$I_F = 5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	_	5	10	nC
	t _a	$T_{J} = 25 \text{ °C}$	_	7	-	
Reverse recovery fall time						ns

Notes

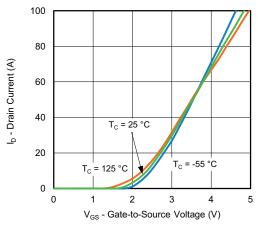
- a. Pulse test: pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Based on characterization, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

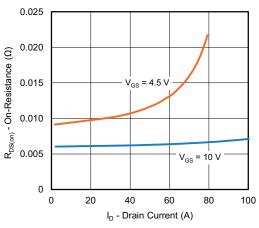




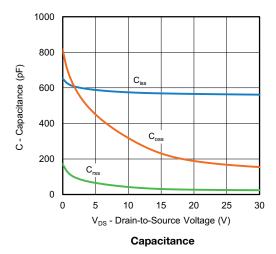
Output Characteristics

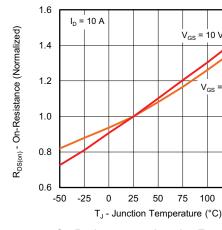


Transfer Characteristics

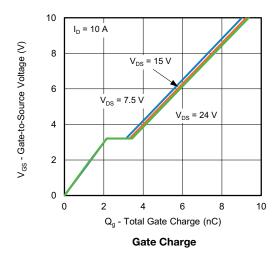


On-Resistance vs. Drain Current





On-Resistance vs. Junction Temperature

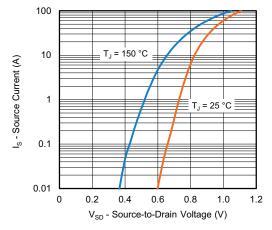


125 150

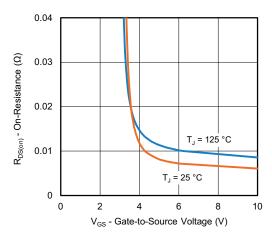
 $V_{GS} = 4.5 V$

100

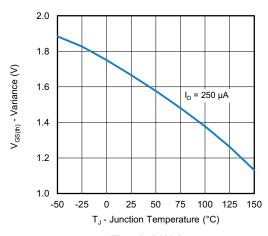




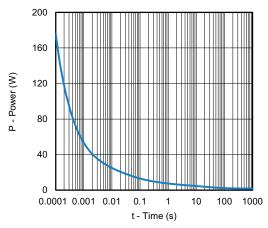
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

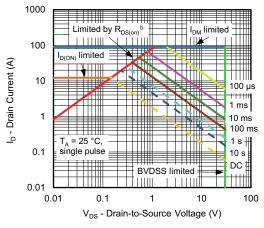


Threshold Voltage

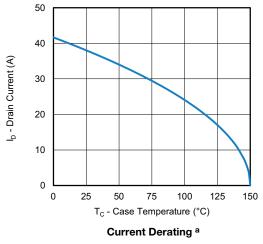


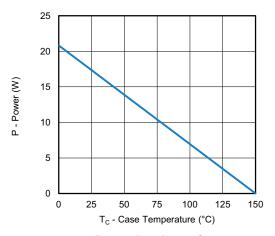
Single Pulse Power, Junction-to-Ambient





Safe Operating Area



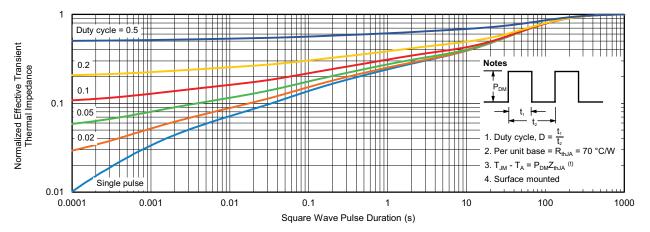


Power, Junction-to-Case

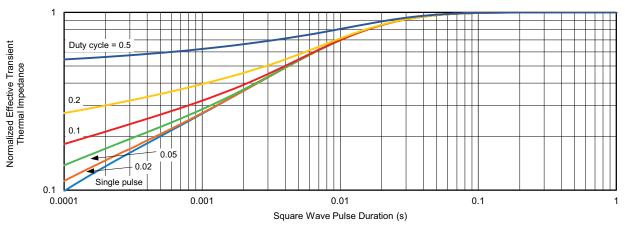
Note

- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit
- b. V_{GS} > minimum VGS at which R_{DS(on)} is specified





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77395.



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Case Outline for PowerPAK® 1212-8S





DIM.		MILLIMETERS		INCHES			
DIIVI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.67	0.75	0.83	0.026	0.030	0.033	
A1	0.00	-	0.05	0.000	-	0.002	
A3		0.20 ref.			0.008 ref		
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е		0.65 bsc.			0.026 bsc.		
K		0.76 ref.			0.030 ref.		
K1	0.41 ref.		0.016 ref.				
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.				0.021 ref.		

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DWG: 6008



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